

## PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Cheng-Hsien Wu</td> <td>03/28/2012</td> </tr> <tr> <td>Cheng-Hao Chiu</td> <td>03/28/2012</td> </tr> <tr> <td>Chieh-Ju Wu</td> <td>03/28/2012</td> </tr> <tr> <td>Kai-En Chang</td> <td>03/28/2012</td> </tr> </tbody> </table>		Name	Execution Date	Cheng-Hsien Wu	03/28/2012	Cheng-Hao Chiu	03/28/2012	Chieh-Ju Wu	03/28/2012	Kai-En Chang	03/28/2012
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Chieh-Ju Wu	03/28/2012										
Kai-En Chang	03/28/2012										
RECEIVING PARTY DATA											
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City:	Kaohsiung										
State/Country:	TAIWAN										
Postal Code:	R.O.C.										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13455214</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13455214						
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Application Number:	13455214										
CORRESPONDENCE DATA											
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Total Attachments: 2 source=20120425092954#page1.tif source=20120425092954#page2.tif											

OP \$40.00 13455214

ASSIGNMENT

WHEREAS, I/We

(1) Wu, Cheng-Hsien of Kaohsiung, Taiwan,

(2) Chiu, Cheng-Hao of Kaohsiung, Taiwan,

hereafter referred to as applicant, have invented certain new and useful improvements in Mold mechanism having electrically adjusting and positioning functions for which an application for a United States Patent was executed on March 28, 2012, and

WHEREAS, National Kaohsiung University of Applied Sciences of Kaohsiung, Taiwan herein referred to as "Assignee" whose mailing address is No. 415, Chien-Kung Rd., Kaohsiung, Taiwan, R.O.C. is desirous of acquiring the entire right, title and interest in and to said invention, and in and to and under any and all Letters Patent to be obtained thereon;

NOW, THEREFORE, for and in consideration of One Dollar (\$1.00) and other good and valuable considerations to me in hand paid by said Assignee, the receipt of which is hereby acknowledged, I have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the said Assignee, its successors and assigns, my entire right, title and interest in and to said invention, said application and the Letters Patent, both foreign and domestic, that may or shall issue, including all of my rights under International Convention, and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to the above-mentioned assignee in accordance herewith.

Upon said consideration, I do hereby covenant and agree with the said assignee, its successors and assigns, that I will not execute any writing or do any act whatsoever conflicting with these presents, and that I or my executors or administrators will at any time upon request, without further or additional consideration, but at the expense of said assignee, its successors and assigns, execute such additional writings and do such additional acts as said assignee, its successors and assigns, may deem necessary or desirable to perfect the assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuation, reissued or extended Letters Patent of the United States, or of any and all foreign countries on said invention, and in enforcing any rights, occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

(1) Date March 28, 2012 Name of Inventor Chiu, Cheng-Hao

(2) Date March 28, 2012 Name of Inventor Wu, Cheng-Hsien

Note: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than two signatures are required.

ASSIGNMENT

WHEREAS, I/We

(3) Wu, Chieh-Ju of Taichung, Taiwan,

(4) Chang, Kai-En of Taichung, Taiwan,

hereafter referred to as applicant, have invented certain new and useful improvements in Mold mechanism having electrically adjusting and positioning functions for which an application for a United States Patent was executed on March 28, 2012, and

WHEREAS, National Kaohsiung University of Applied Sciences of Kaohsiung, Taiwan herein referred to as "Assignee" whose mailing address is No. 415, Chien-Kung Rd., Kaohsiung, Taiwan, R.O.C. is desirous of acquiring the entire right, title and interest in and to said invention, and in and to and under any and all Letters Patent to be obtained thereon;

NOW, THEREFORE, for and in consideration of One Dollar (\$1.00) and other good and valuable considerations to me in hand paid by said Assignee, the receipt of which is hereby acknowledged, I have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the said Assignee, its successors and assigns, my entire right, title and interest in and to said invention, said application and the Letters Patent, both foreign and domestic, that may or shall issue, including all of my rights under International Convention, and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to the above-mentioned assignee in accordance herewith.

Upon said consideration, I do hereby covenant and agree with the said assignee, its successors and assigns, that I will not execute any writing or do any act whatsoever conflicting with these presents, and that I or my executors or administrators will at any time upon request, without further or additional consideration, but at the expense of said assignee, its successors and assigns, execute such additional writings and do such additional acts as said assignee, its successors and assigns, may deem necessary or desirable to perfect the assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuation, reissued or extended Letters Patent of the United States, or of any and all foreign countries on said invention, and in enforcing any rights, occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

(3) Date March 28, 2012 Name of Inventor Wu, Chiehju

(4) Date March 28, 2012 Name of Inventor Chang, Kaien

Note: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than two signatures are required.